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#### Details

Product Status	Last Time Buy
Core Processor	XC800
Core Size	8-Bit
Speed	24MHz
Connectivity	CANbus, SSI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	34
Program Memory Size	24KB (24K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1.75K x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	-
Package / Case	-
Supplier Device Package	-
Purchase URL	<a href="https://www.e-xfl.com/product-detail/infineon-technologies/xc886c6ffa5vackxuma1">https://www.e-xfl.com/product-detail/infineon-technologies/xc886c6ffa5vackxuma1</a>

## XC886/888 Data Sheet

### Revision History: V1.2 2009-07

Previous Versions: V1.0, V1.1

Page	Subjects (major changes since last revision)
Changes from V1.1 2009-01 to V1.2 2009-07	
<b>89</b>	Note on LIN baud rate detection is added.
<b>92</b>	RXD slave line in SSC block diagram is updated.
<b>108</b>	Electrical parameters are now valid for all variants, previous note on exclusion of ROM variants is removed.
<b>116</b>	Symbol for ADC error parameters are updated.
<b>120</b>	Power supply current parameters for ROM variants are updated.
<b>128</b>	Test condition for the on-chip oscillator short term deviation is updated.

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**Summary of Features**
**Table 2      Device Profile (cont'd)**

Sales Type	Device Type	Program Memory (Kbytes)	Power Supply (V)	Temperature (°C)	Quality Profile
SAK-XC886*/888*-8FFA 3V3	Flash	32	3.3	-40 to 125	Automotive
SAK-XC886*/888*-6FFA 3V3	Flash	24	3.3	-40 to 125	Automotive
SAF-XC886*/888*-8FFA 3V3	Flash	32	3.3	-40 to 85	Automotive
SAF-XC886*/888*-6FFA 3V3	Flash	24	3.3	-40 to 85	Automotive
SAF-XC886*/888*-8FFI 3V3	Flash	32	3.3	-40 to 85	Industrial
SAF-XC886*/888*-6FFI 3V3	Flash	24	3.3	-40 to 85	Industrial

*Note: The asterisk (\*) above denotes the device configuration letters from [Table 1](#). Corresponding ROM derivatives will be available on request.*

*Note: For variants with LIN BSL support, only LIN BSL is available regardless of the availability of the CAN module.*

As this document refers to all the derivatives, some description may not apply to a specific product. For simplicity, all versions are referred to by the term XC886/888 throughout this document.

**Ordering Information**

The ordering code for Infineon Technologies microcontrollers provides an exact reference to the required product. This ordering code identifies:

- The derivative itself, i.e. its function set, the temperature range, and the supply voltage
- The package and the type of delivery

For the available ordering codes for the XC886/888, please refer to your responsible sales representative or your local distributor.

*Note: The ordering codes for the Mask-ROM versions are defined for each product after verification of the respective ROM code.*

## Functional Description

code or data. Therefore, even though the ROM device contains either a 24-Kbyte or 32-Kbyte ROM, the maximum size of code that can be placed in the ROM is the given size less four bytes.

### 3.2.1 Memory Protection Strategy

The XC886/888 memory protection strategy includes:

- Read-out protection: The user is able to protect the contents in the Flash (for Flash devices) and ROM (for ROM devices) memory from being read
  - Flash protection is enabled by programming a valid password (8-bit non-zero value) via BSL mode 6.
  - ROM protection is fixed with the ROM mask and is always enabled.
- Flash program and erase protection: This feature is available only for Flash devices.

#### 3.2.1.1 Flash Memory Protection

As long as a valid password is available, all external access to the device, including the Flash, will be blocked.

For additional security, the Flash hardware protection can be enabled to implement a second layer of read-out protection, as well as to enable program and erase protection.

Flash hardware protection is available only for Flash devices and comes in two modes:

- Mode 0: Only the P-Flash is protected; the D-Flash is unprotected
- Mode 1: Both the P-Flash and D-Flash are protected

The selection of each protection mode and the restrictions imposed are summarized in [Table 4](#).

**Table 4 Flash Protection Modes**

Flash Protection	Without hardware protection			With hardware protection	
Hardware Protection Mode	-	0	1		
Activation	Program a valid password via BSL mode 6				
Selection	Bit 4 of password = 0	Bit 4 of password = 1	MSB of password = 0	Bit 4 of password = 1	MSB of password = 1
P-Flash contents can be read by	Read instructions in any program memory	Read instructions in the P-Flash		Read instructions in the P-Flash or D-Flash	
External access to P-Flash	Not possible	Not possible		Not possible	

### 3.2.2 Special Function Register

The Special Function Registers (SFRs) occupy direct internal data memory space in the range  $80_H$  to  $FF_H$ . All registers, except the program counter, reside in the SFR area. The SFRs include pointers and registers that provide an interface between the CPU and the on-chip peripherals. As the 128-SFR range is less than the total number of registers required, address extension mechanisms are required to increase the number of addressable SFRs. The address extension mechanisms include:

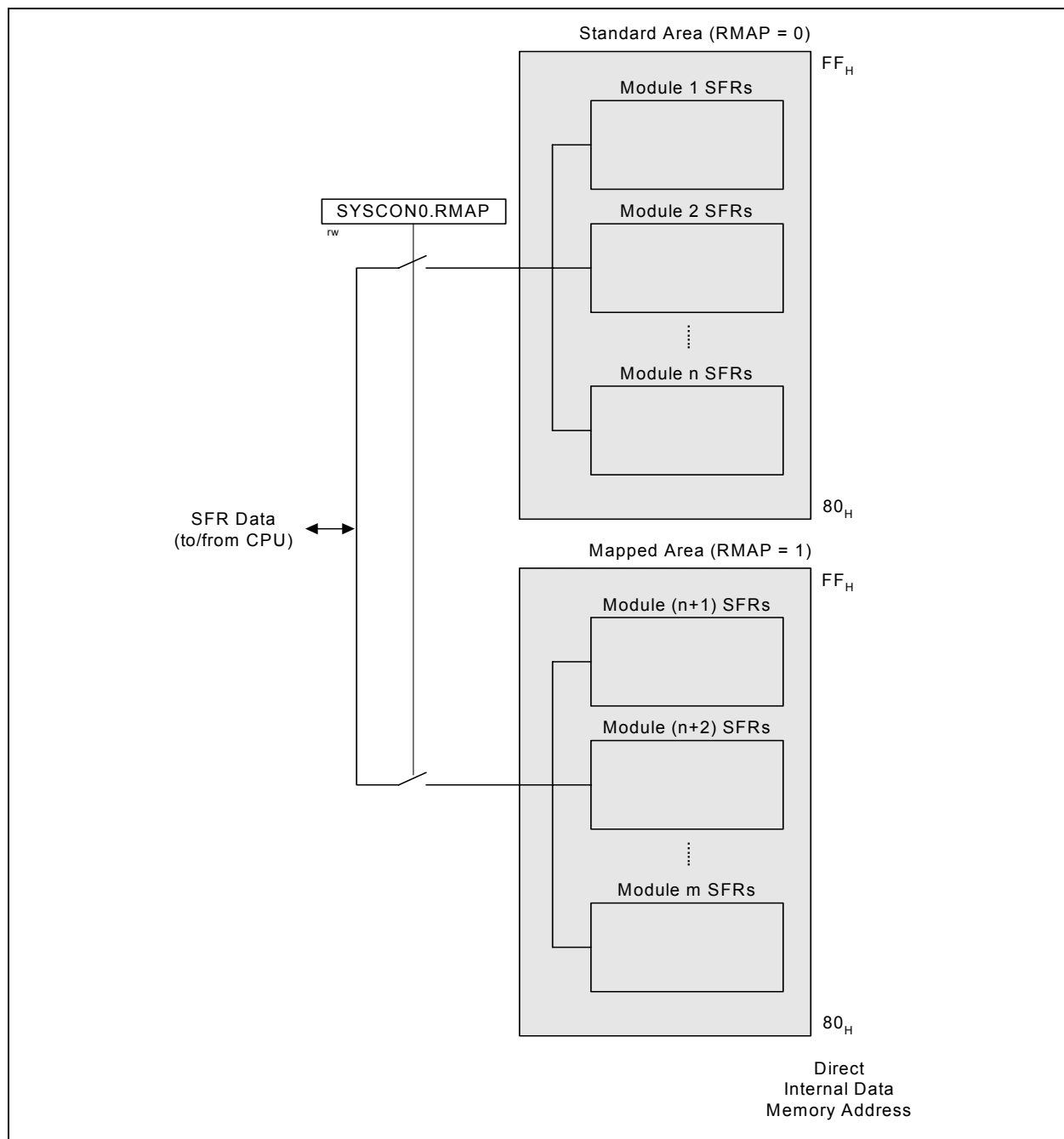
- Mapping
- Paging

#### 3.2.2.1 Address Extension by Mapping

Address extension is performed at the system level by mapping. The SFR area is extended into two portions: the standard (non-mapped) SFR area and the mapped SFR area. Each portion supports the same address range  $80_H$  to  $FF_H$ , bringing the number of addressable SFRs to 256. The extended address range is not directly controlled by the CPU instruction itself, but is derived from bit RMAP in the system control register SYSCON0 at address  $8F_H$ . To access SFRs in the mapped area, bit RMAP in SFR SYSCON0 must be set. Alternatively, the SFRs in the standard area can be accessed by clearing bit RMAP. The SFR area can be selected as shown in [Figure 8](#).

As long as bit RMAP is set, the mapped SFR area can be accessed. This bit is not cleared automatically by hardware. Thus, before standard/mapped registers are accessed, bit RMAP must be cleared/set, respectively, by software.

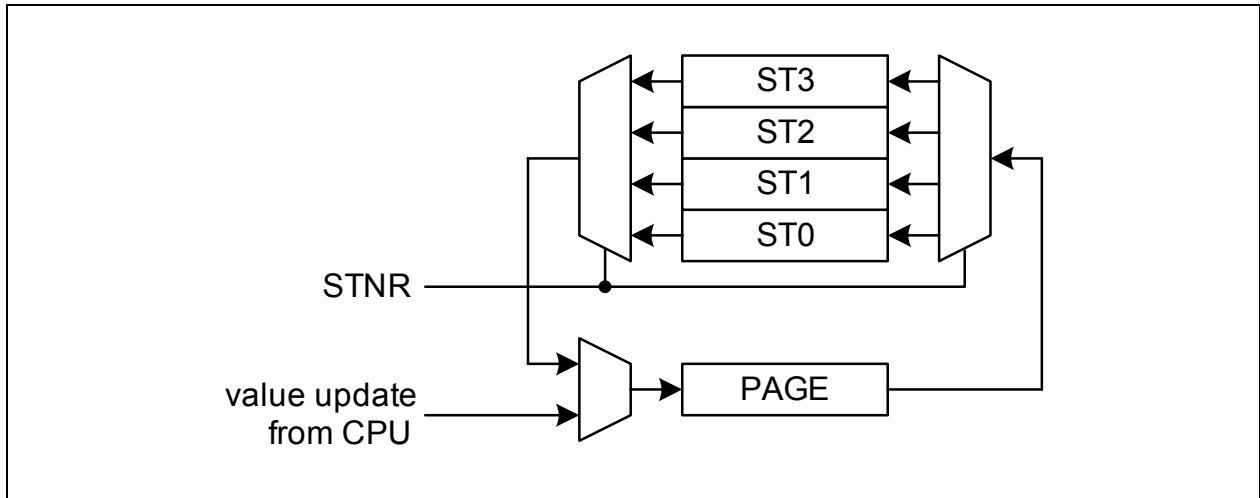
## Functional Description



**Figure 8 Address Extension by Mapping**

## Functional Description

- Overwrite the contents of PAGE with the contents of STx, ignoring the value written to the bit positions of PAGE  
(this is done at the end of the interrupt routine to restore the previous page setting before the interrupt occurred)



**Figure 10 Storage Elements for Paging**

With this mechanism, a certain number of interrupt routines (or other routines) can perform page changes without reading and storing the previously used page information. The use of only write operations makes the system simpler and faster. Consequently, this mechanism significantly improves the performance of short interrupt routines.

The XC886/888 supports local address extension for:

- Parallel Ports
- Analog-to-Digital Converter (ADC)
- Capture/Compare Unit 6 (CCU6)
- System Control Registers

## Functional Description

The page register has the following definition:

### MOD\_PAGE

Page Register for module MOD

Reset Value: 00<sub>H</sub>

7	6	5	4	3	2	1	0
OP		STNR		0	PAGE		
w		w		r	rw		

Field	Bits	Type	Description
PAGE	[2:0]	rw	<b>Page Bits</b> When written, the value indicates the new page. When read, the value indicates the currently active page.
STNR	[5:4]	w	<b>Storage Number</b> This number indicates which storage bit field is the target of the operation defined by bit field OP. If OP = 10 <sub>B</sub> , the contents of PAGE are saved in STx before being overwritten with the new value. If OP = 11 <sub>B</sub> , the contents of PAGE are overwritten by the contents of STx. The value written to the bit positions of PAGE is ignored.  00 ST0 is selected. 01 ST1 is selected. 10 ST2 is selected. 11 ST3 is selected.



## Functional Description

### 3.2.4 XC886/888 Register Overview

The SFRs of the XC886/888 are organized into groups according to their functional units. The contents (bits) of the SFRs are summarized in [Chapter 3.2.4.1](#) to [Chapter 3.2.4.14](#).

*Note: The addresses of the bitaddressable SFRs appear in bold typeface.*

#### 3.2.4.1 CPU Registers

The CPU SFRs can be accessed in both the standard and mapped memory areas (RMAP = 0 or 1).

**Table 5 CPU Register Overview**

Addr	Register Name	Bit	7	6	5	4	3	2	1	0
RMAP = 0 or 1										
81 <sub>H</sub>	<b>SP</b> <b>Reset: 07<sub>H</sub></b> Stack Pointer Register	Bit Field	SP							
		Type	rw							
82 <sub>H</sub>	<b>DPL</b> <b>Reset: 00<sub>H</sub></b> Data Pointer Register Low	Bit Field	DPL7	DPL6	DPL5	DPL4	DPL3	DPL2	DPL1	DPL0
		Type	rw	rw	rw	rw	rw	rw	rw	rw
83 <sub>H</sub>	<b>DPH</b> <b>Reset: 00<sub>H</sub></b> Data Pointer Register High	Bit Field	DPH7	DPH6	DPH5	DPH4	DPH3	DPH2	DPH1	DPH0
		Type	rw	rw	rw	rw	rw	rw	rw	rw
87 <sub>H</sub>	<b>PCON</b> <b>Reset: 00<sub>H</sub></b> Power Control Register	Bit Field	SMOD	0			GF1	GF0	0	IDLE
		Type	rw	r			rw	rw	r	rw
88 <sub>H</sub>	<b>TCON</b> <b>Reset: 00<sub>H</sub></b> Timer Control Register	Bit Field	TF1	TR1	TF0	TR0	IE1	IT1	IE0	IT0
		Type	rwh	rw	rwh	rw	rwh	rw	rwh	rw
89 <sub>H</sub>	<b>TMOD</b> <b>Reset: 00<sub>H</sub></b> Timer Mode Register	Bit Field	GATE 1	T1S	T1M		GATE 0	T0S	T0M	
		Type	rw	rw	rw		rw	rw	rw	
8A <sub>H</sub>	<b>TL0</b> <b>Reset: 00<sub>H</sub></b> Timer 0 Register Low	Bit Field	VAL							
		Type	rwh							
8B <sub>H</sub>	<b>TL1</b> <b>Reset: 00<sub>H</sub></b> Timer 1 Register Low	Bit Field	VAL							
		Type	rwh							
8C <sub>H</sub>	<b>TH0</b> <b>Reset: 00<sub>H</sub></b> Timer 0 Register High	Bit Field	VAL							
		Type	rwh							
8D <sub>H</sub>	<b>TH1</b> <b>Reset: 00<sub>H</sub></b> Timer 1 Register High	Bit Field	VAL							
		Type	rwh							
98 <sub>H</sub>	<b>SCON</b> <b>Reset: 00<sub>H</sub></b> Serial Channel Control Register	Bit Field	SM0	SM1	SM2	REN	TB8	RB8	TI	RI
		Type	rw	rw	rw	rw	rw	rwh	rwh	rwh
99 <sub>H</sub>	<b>SBUF</b> <b>Reset: 00<sub>H</sub></b> Serial Data Buffer Register	Bit Field	VAL							
		Type	rwh							
A2 <sub>H</sub>	<b>EO</b> <b>Reset: 00<sub>H</sub></b> Extended Operation Register	Bit Field	0			TRAP_ EN	0			DPSE L0
		Type	r			rw	r			rw

**Functional Description**
**Table 5 CPU Register Overview (cont'd)**

Addr	Register Name	Bit	7	6	5	4	3	2	1	0
A8 <sub>H</sub>	<b>IEN0</b> Reset: 00 <sub>H</sub> Interrupt Enable Register 0	Bit Field	EA	0	ET2	ES	ET1	EX1	ET0	EX0
		Type	rw	r	rw	rw	rw	rw	rw	rw
B8 <sub>H</sub>	<b>IP</b> Reset: 00 <sub>H</sub> Interrupt Priority Register	Bit Field	0		PT2	PS	PT1	PX1	PT0	PX0
		Type	r		rw	rw	rw	rw	rw	rw
B9 <sub>H</sub>	<b>IPH</b> Reset: 00 <sub>H</sub> Interrupt Priority High Register	Bit Field	0		PT2H	PSH	PT1H	PX1H	PT0H	PX0H
		Type	r		rw	rw	rw	rw	rw	rw
D0 <sub>H</sub>	<b>PSW</b> Reset: 00 <sub>H</sub> Program Status Word Register	Bit Field	CY	AC	F0	RS1	RS0	OV	F1	P
		Type	rwh	rwh	rw	rw	rw	rwh	rw	rh
E0 <sub>H</sub>	<b>ACC</b> Reset: 00 <sub>H</sub> Accumulator Register	Bit Field	ACC7	ACC6	ACC5	ACC4	ACC3	ACC2	ACC1	ACC0
		Type	rw	rw	rw	rw	rw	rw	rw	rw
E8 <sub>H</sub>	<b>IEN1</b> Reset: 00 <sub>H</sub> Interrupt Enable Register 1	Bit Field	ECCIP 3	ECCIP 2	ECCIP 1	ECCIP 0	EXM	EX2	ESSC	EADC
		Type	rw	rw	rw	rw	rw	rw	rw	rw
F0 <sub>H</sub>	<b>B</b> Reset: 00 <sub>H</sub> B Register	Bit Field	B7	B6	B5	B4	B3	B2	B1	B0
		Type	rw	rw	rw	rw	rw	rw	rw	rw
F8 <sub>H</sub>	<b>IP1</b> Reset: 00 <sub>H</sub> Interrupt Priority 1 Register	Bit Field	PCCIP 3	PCCIP 2	PCCIP 1	PCCIP 0	PXM	PX2	PSSC	PADC
		Type	rw	rw	rw	rw	rw	rw	rw	rw
F9 <sub>H</sub>	<b>IPH1</b> Reset: 00 <sub>H</sub> Interrupt Priority 1 High Register	Bit Field	PCCIP 3H	PCCIP 2H	PCCIP 1H	PCCIP 0H	PXMH	PX2H	PSSC H	PADC H
		Type	rw	rw	rw	rw	rw	rw	rw	rw

**3.2.4.2 MDU Registers**

The MDU SFRs can be accessed in the mapped memory area (RMAP = 1).

**Table 6 MDU Register Overview**

Addr	Register Name	Bit	7	6	5	4	3	2	1	0
RMAP = 1										
B0 <sub>H</sub>	<b>MDUSTAT</b> <b>Reset: 00<sub>H</sub></b> MDU Status Register	Bit Field	0					BSY	IERR	IRDY
		Type	r					rh	rwh	rwh
B1 <sub>H</sub>	<b>MDUCON</b> <b>Reset: 00<sub>H</sub></b> MDU Control Register	Bit Field	IE	IR	RSEL	STAR T	OPCODE			
		Type	rw	rw	rw	rwh	rw			
B2 <sub>H</sub>	<b>MD0</b> <b>Reset: 00<sub>H</sub></b> MDU Operand Register 0	Bit Field	DATA							
		Type	rw							
B2 <sub>H</sub>	<b>MR0</b> <b>Reset: 00<sub>H</sub></b> MDU Result Register 0	Bit Field	DATA							
		Type	rh							
B3 <sub>H</sub>	<b>MD1</b> <b>Reset: 00<sub>H</sub></b> MDU Operand Register 1	Bit Field	DATA							
		Type	rw							

## Functional Description

**Table 6 MDU Register Overview (cont'd)**

Addr	Register Name	Bit	7	6	5	4	3	2	1	0
B3 <sub>H</sub>	<b>MR1</b> Reset: 00 <sub>H</sub> MDU Result Register 1	Bit Field	DATA							
		Type	rh							
B4 <sub>H</sub>	<b>MD2</b> Reset: 00 <sub>H</sub> MDU Operand Register 2	Bit Field	DATA							
		Type	rw							
B4 <sub>H</sub>	<b>MR2</b> Reset: 00 <sub>H</sub> MDU Result Register 2	Bit Field	DATA							
		Type	rh							
B5 <sub>H</sub>	<b>MD3</b> Reset: 00 <sub>H</sub> MDU Operand Register 3	Bit Field	DATA							
		Type	rw							
B5 <sub>H</sub>	<b>MR3</b> Reset: 00 <sub>H</sub> MDU Result Register 3	Bit Field	DATA							
		Type	rh							
B6 <sub>H</sub>	<b>MD4</b> Reset: 00 <sub>H</sub> MDU Operand Register 4	Bit Field	DATA							
		Type	rw							
B6 <sub>H</sub>	<b>MR4</b> Reset: 00 <sub>H</sub> MDU Result Register 4	Bit Field	DATA							
		Type	rh							
B7 <sub>H</sub>	<b>MD5</b> Reset: 00 <sub>H</sub> MDU Operand Register 5	Bit Field	DATA							
		Type	rw							
B7 <sub>H</sub>	<b>MR5</b> Reset: 00 <sub>H</sub> MDU Result Register 5	Bit Field	DATA							
		Type	rh							

### 3.2.4.3 CORDIC Registers

The CORDIC SFRs can be accessed in the mapped memory area (RMAP = 1).

**Table 7 CORDIC Register Overview**

Addr	Register Name	Bit	7	6	5	4	3	2	1	0
RMAP = 1										
9A <sub>H</sub>	<b>CD_CORDXL</b> Reset: 00 <sub>H</sub> CORDIC X Data Low Byte	Bit Field	DATAL							
		Type	rw							
9B <sub>H</sub>	<b>CD_CORDXH</b> Reset: 00 <sub>H</sub> CORDIC X Data High Byte	Bit Field	DATAH							
		Type	rw							
9C <sub>H</sub>	<b>CD_CORDYL</b> Reset: 00 <sub>H</sub> CORDIC Y Data Low Byte	Bit Field	DATAL							
		Type	rw							
9D <sub>H</sub>	<b>CD_CORDYH</b> Reset: 00 <sub>H</sub> CORDIC Y Data High Byte	Bit Field	DATAH							
		Type	rw							
9E <sub>H</sub>	<b>CD_CORDZL</b> Reset: 00 <sub>H</sub> CORDIC Z Data Low Byte	Bit Field	DATAL							
		Type	rw							
9F <sub>H</sub>	<b>CD_CORDZH</b> Reset: 00 <sub>H</sub> CORDIC Z Data High Byte	Bit Field	DATAH							
		Type	rw							

**Functional Description**
**Table 8 SCU Register Overview (cont'd)**

Addr	Register Name	Bit	7	6	5	4	3	2	1	0
BC <sub>H</sub>	<b>NMISR</b> <b>Reset: 00<sub>H</sub></b> NMI Status Register	Bit Field	0	FNMI ECC	FNMI VDDP	FNMI VDD	FNMI OCDS	FNMI FLASH	FNMI PLL	FNMI WDT
		Type	r	rwh	rwh	rwh	rwh	rwh	rwh	rwh
BD <sub>H</sub>	<b>BCON</b> <b>Reset: 00<sub>H</sub></b> Baud Rate Control Register	Bit Field	BGSEL		0	BRDIS	BRPRE			R
		Type	rw		r	rw	rw			rw
BE <sub>H</sub>	<b>BG</b> <b>Reset: 00<sub>H</sub></b> Baud Rate Timer/Reload Register	Bit Field	BR_VALUE							
		Type	rwh							
E9 <sub>H</sub>	<b>FDCON</b> <b>Reset: 00<sub>H</sub></b> Fractional Divider Control Register	Bit Field	BGS	SYNE N	ERRS YN	EOFS YN	BRK	NDOV	FDM	FDEN
		Type	rw	rw	rwh	rwh	rwh	rwh	rw	rw
EA <sub>H</sub>	<b>FDSTEP</b> <b>Reset: 00<sub>H</sub></b> Fractional Divider Reload Register	Bit Field	STEP							
		Type	rw							
EB <sub>H</sub>	<b>FDRES</b> <b>Reset: 00<sub>H</sub></b> Fractional Divider Result Register	Bit Field	RESULT							
		Type	rh							
RMAP = 0, PAGE 1										
B3 <sub>H</sub>	<b>ID</b> <b>Reset: UU<sub>H</sub></b> Identity Register	Bit Field	PRODID					VERID		
		Type	r					r		
B4 <sub>H</sub>	<b>PMCON0</b> <b>Reset: 00<sub>H</sub></b> Power Mode Control Register 0	Bit Field	0	WDT RST	WKRS	WK SEL	SD	PD	WS	
		Type	r	rwh	rwh	rw	rw	rwh	rw	
B5 <sub>H</sub>	<b>PMCON1</b> <b>Reset: 00<sub>H</sub></b> Power Mode Control Register 1	Bit Field	0	CDC_ DIS	CAN_ DIS	MDU_ DIS	T2_ DIS	CCU_ DIS	SSC_ DIS	ADC_ DIS
		Type	r	rw	rw	rw	rw	rw	rw	rw
B6 <sub>H</sub>	<b>OSC_CON</b> <b>Reset: 08<sub>H</sub></b> OSC Control Register	Bit Field	0			OSC PD	XPD	OSC SS	ORD RES	OSCR
		Type	r			rw	rw	rw	rwh	rh
B7 <sub>H</sub>	<b>PLL_CON</b> <b>Reset: 90<sub>H</sub></b> PLL Control Register	Bit Field	NDIV				VCO BYP	OSC DISC	RESL D	LOCK
		Type	rw				rw	rw	rwh	rh
BA <sub>H</sub>	<b>CMCON</b> <b>Reset: 10<sub>H</sub></b> Clock Control Register	Bit Field	VCO SEL	KDIV	0	FCCF G	CLKREL			
		Type	rw	rw	r	rw	rw			
BB <sub>H</sub>	<b>PASSWD</b> <b>Reset: 07<sub>H</sub></b> Password Register	Bit Field	PASS					PROT ECT_S	MODE	
		Type	wh					rh	rw	
BC <sub>H</sub>	<b>FEAL</b> <b>Reset: 00<sub>H</sub></b> Flash Error Address Register Low	Bit Field	ECCERRADDR							
		Type	rh							
BD <sub>H</sub>	<b>FEAH</b> <b>Reset: 00<sub>H</sub></b> Flash Error Address Register High	Bit Field	ECCERRADDR							
		Type	rh							

**Functional Description**
**Table 11 ADC Register Overview (cont'd)**

Addr	Register Name	Bit	7	6	5	4	3	2	1	0
CD <sub>H</sub>	<b>ADC_LCBR</b> <b>Reset: B7<sub>H</sub></b> Limit Check Boundary Register	Bit Field	BOUND1				BOUND0			
		Type	rw				rw			
CE <sub>H</sub>	<b>ADC_INPCR0</b> <b>Reset: 00<sub>H</sub></b> Input Class 0 Register	Bit Field	STC							
		Type	rw							
CF <sub>H</sub>	<b>ADC_ETRCR</b> <b>Reset: 00<sub>H</sub></b> External Trigger Control Register	Bit Field	SYNE N1	SYNE N0	ETRSEL1			ETRSEL0		
		Type	rw	rw	rw			rw		
RMAP = 0, PAGE 1										
CA <sub>H</sub>	<b>ADC_CHCTR0</b> <b>Reset: 00<sub>H</sub></b> Channel Control Register 0	Bit Field	0	LCC			0	RESRSEL		
		Type	r	rw			r	rw		
CB <sub>H</sub>	<b>ADC_CHCTR1</b> <b>Reset: 00<sub>H</sub></b> Channel Control Register 1	Bit Field	0	LCC			0	RESRSEL		
		Type	r	rw			r	rw		
CC <sub>H</sub>	<b>ADC_CHCTR2</b> <b>Reset: 00<sub>H</sub></b> Channel Control Register 2	Bit Field	0	LCC			0	RESRSEL		
		Type	r	rw			r	rw		
CD <sub>H</sub>	<b>ADC_CHCTR3</b> <b>Reset: 00<sub>H</sub></b> Channel Control Register 3	Bit Field	0	LCC			0	RESRSEL		
		Type	r	rw			r	rw		
CE <sub>H</sub>	<b>ADC_CHCTR4</b> <b>Reset: 00<sub>H</sub></b> Channel Control Register 4	Bit Field	0	LCC			0	RESRSEL		
		Type	r	rw			r	rw		
CF <sub>H</sub>	<b>ADC_CHCTR5</b> <b>Reset: 00<sub>H</sub></b> Channel Control Register 5	Bit Field	0	LCC			0	RESRSEL		
		Type	r	rw			r	rw		
D2 <sub>H</sub>	<b>ADC_CHCTR6</b> <b>Reset: 00<sub>H</sub></b> Channel Control Register 6	Bit Field	0	LCC			0	RESRSEL		
		Type	r	rw			r	rw		
D3 <sub>H</sub>	<b>ADC_CHCTR7</b> <b>Reset: 00<sub>H</sub></b> Channel Control Register 7	Bit Field	0	LCC			0	RESRSEL		
		Type	r	rw			r	rw		
RMAP = 0, PAGE 2										
CA <sub>H</sub>	<b>ADC_RESR0L</b> <b>Reset: 00<sub>H</sub></b> Result Register 0 Low	Bit Field	RESULT		0	VF	DRC	CHNR		
		Type	rh		r	rh	rh	rh		
CB <sub>H</sub>	<b>ADC_RESR0H</b> <b>Reset: 00<sub>H</sub></b> Result Register 0 High	Bit Field	RESULT							
		Type	rh							
CC <sub>H</sub>	<b>ADC_RESR1L</b> <b>Reset: 00<sub>H</sub></b> Result Register 1 Low	Bit Field	RESULT		0	VF	DRC	CHNR		
		Type	rh		r	rh	rh	rh		
CD <sub>H</sub>	<b>ADC_RESR1H</b> <b>Reset: 00<sub>H</sub></b> Result Register 1 High	Bit Field	RESULT							
		Type	rh							
CE <sub>H</sub>	<b>ADC_RESR2L</b> <b>Reset: 00<sub>H</sub></b> Result Register 2 Low	Bit Field	RESULT		0	VF	DRC	CHNR		
		Type	rh		r	rh	rh	rh		
CF <sub>H</sub>	<b>ADC_RESR2H</b> <b>Reset: 00<sub>H</sub></b> Result Register 2 High	Bit Field	RESULT							
		Type	rh							
D2 <sub>H</sub>	<b>ADC_RESR3L</b> <b>Reset: 00<sub>H</sub></b> Result Register 3 Low	Bit Field	RESULT		0	VF	DRC	CHNR		
		Type	rh		r	rh	rh	rh		

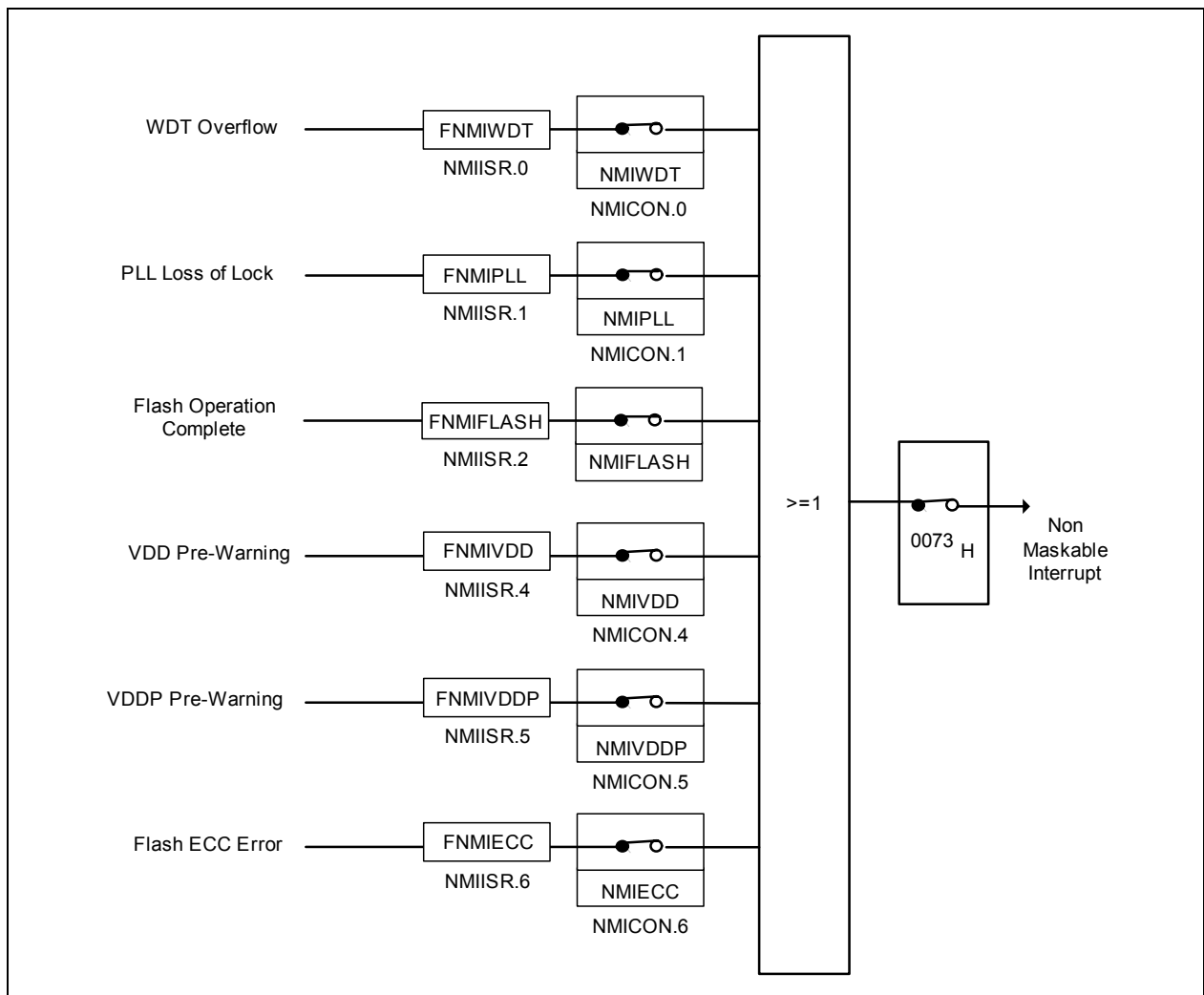
## Functional Description

### 3.4 Interrupt System

The XC800 Core supports one non-maskable interrupt (NMI) and 14 maskable interrupt requests. In addition to the standard interrupt functions supported by the core, e.g., configurable interrupt priority and interrupt masking, the XC886/888 interrupt system provides extended interrupt support capabilities such as the mapping of each interrupt vector to several interrupt sources to increase the number of interrupt sources supported, and additional status registers for detecting and determining the interrupt source.

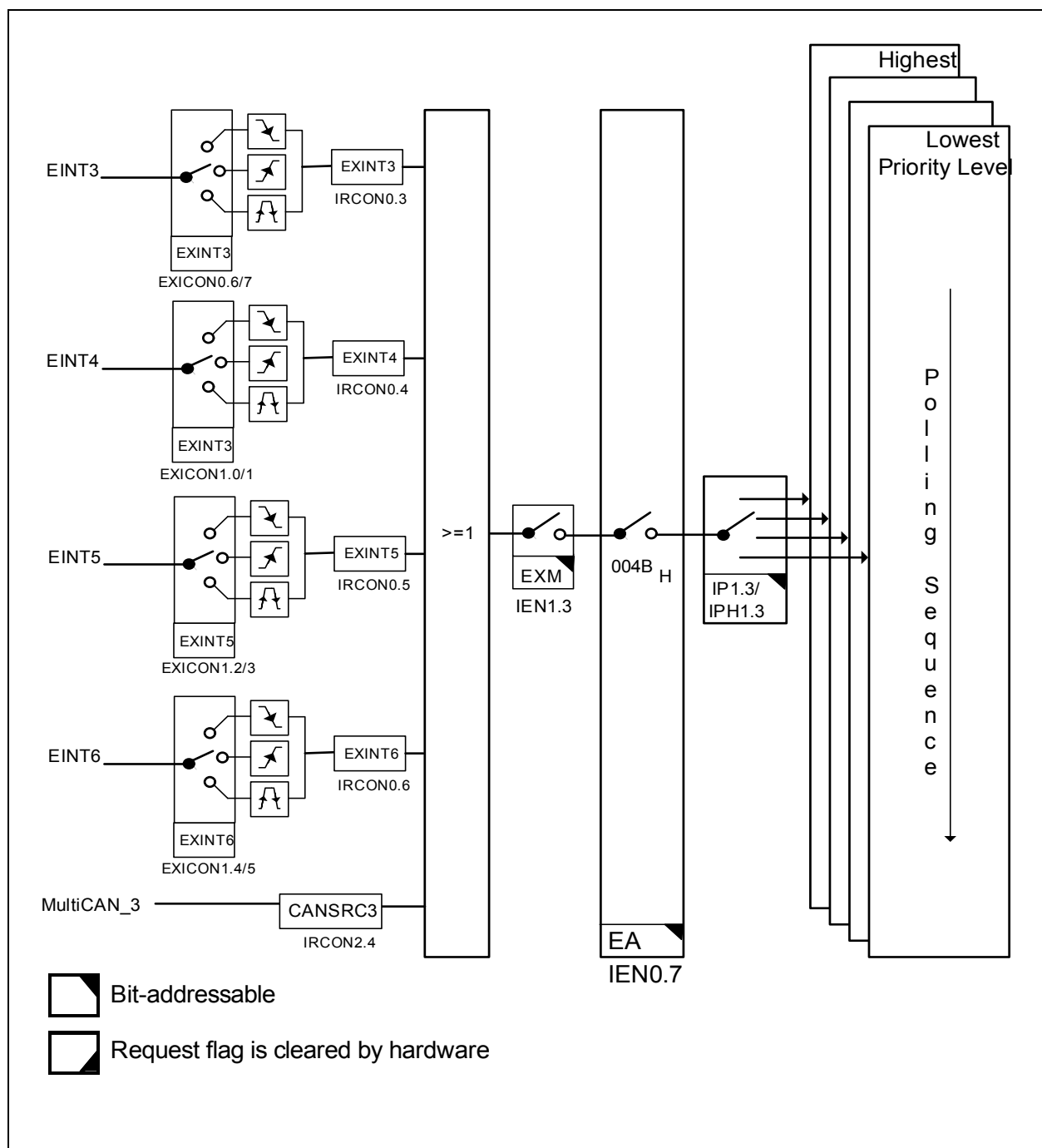
#### 3.4.1 Interrupt Source

**Figure 13** to **Figure 17** give a general overview of the interrupt sources and nodes, and their corresponding control and status flags.



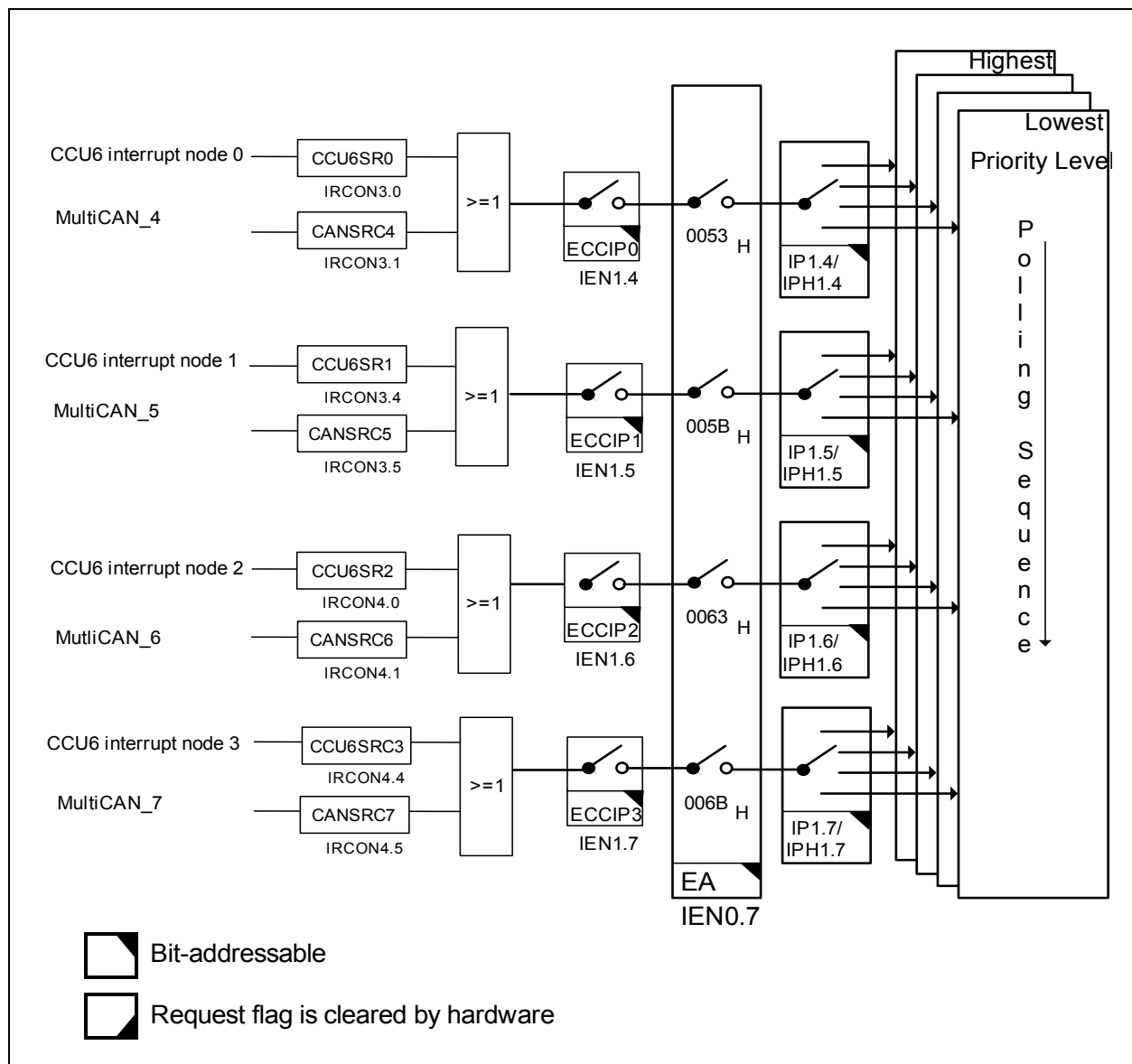
**Figure 13 Non-Maskable Interrupt Request Sources**

# Functional Description



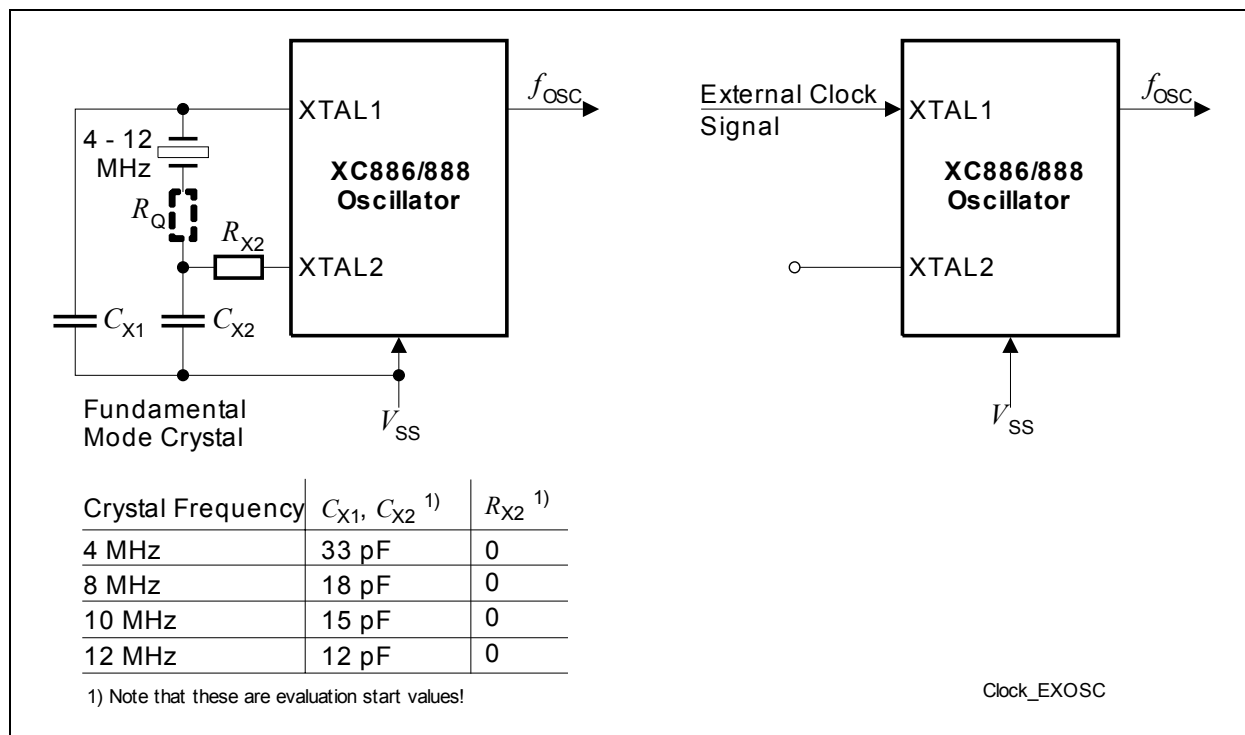
**Figure 17 Interrupt Request Sources (Part 4)**

# Functional Description



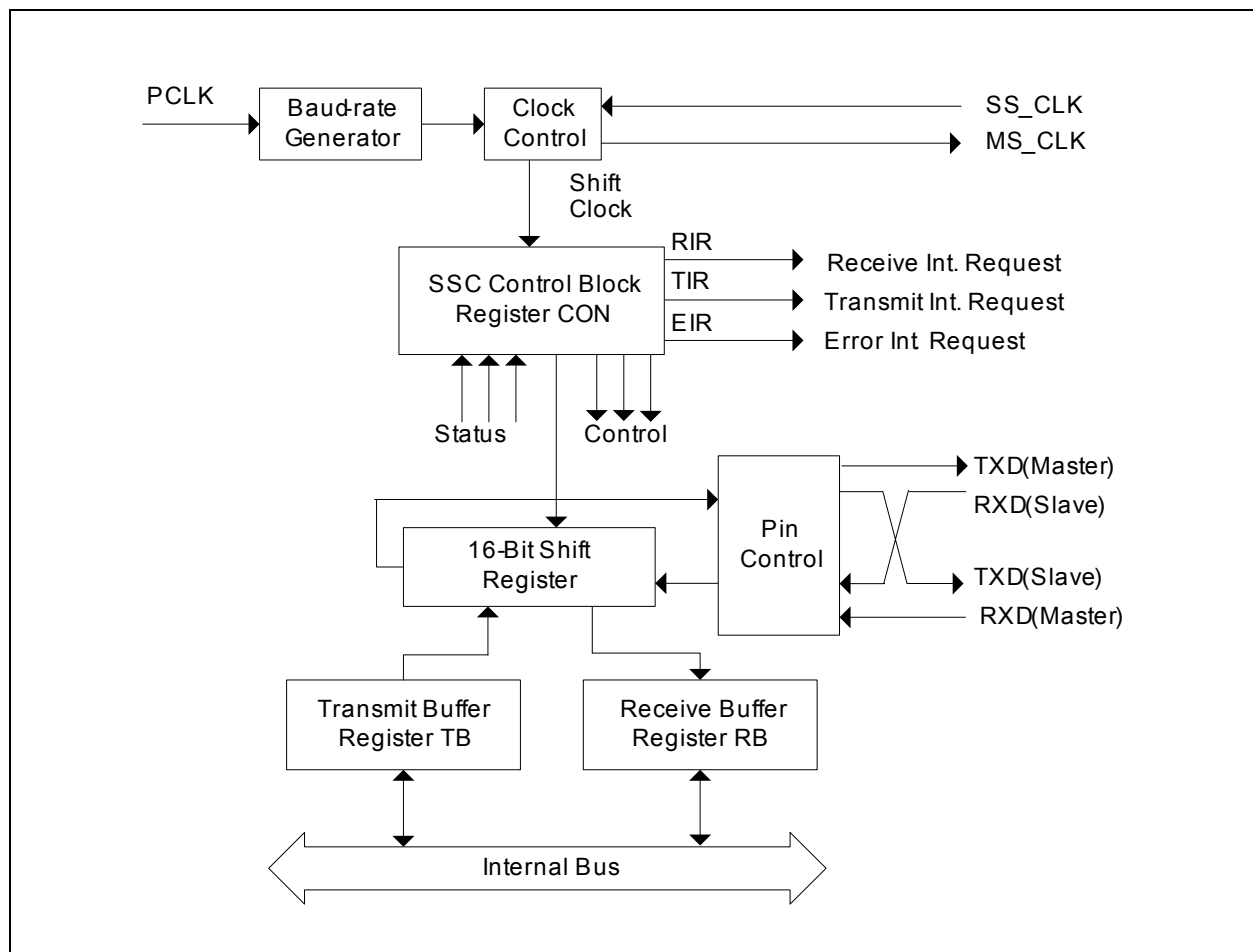
**Figure 18 Interrupt Request Sources (Part 5)**



**Functional Description**

**Figure 25 External Oscillator Circuitry**

*Note: For crystal operation, it is strongly recommended to measure the negative resistance in the final target system (layout) to determine the optimum parameters for the oscillator operation. Please refer to the minimum and maximum values of the negative resistance specified by the crystal supplier.*

## Functional Description



**Figure 32 SSC Block Diagram**

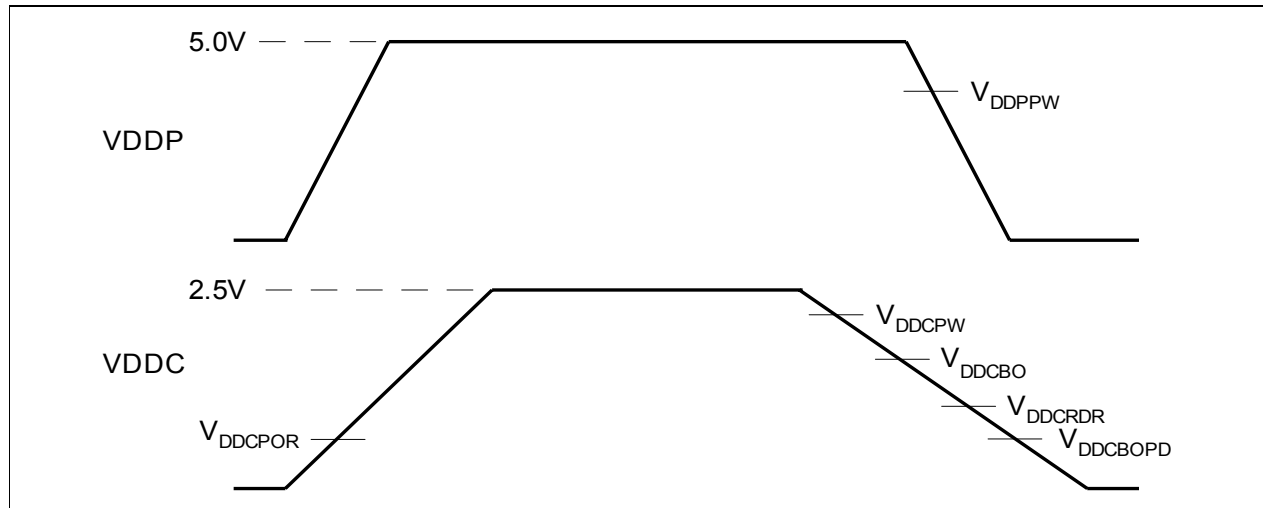
## Functional Description

**Table 36**      **Chip Identification Number (cont'd)**

Product Variant	Chip Identification Number		
	AA-Step	AB-Step	AC-Step
XC886LM-6RFA 3V3	22411522 <sub>H</sub>	-	-
XC888LM-6RFA 3V3	22411523 <sub>H</sub>	-	-
XC886CM-8RFA 3V3	22480502 <sub>H</sub>	-	-
XC888CM-8RFA 3V3	22480503 <sub>H</sub>	-	-
XC886C-8RFA 3V3	22480542 <sub>H</sub>	-	-
XC888C-8RFA 3V3	22480543 <sub>H</sub>	-	-
XC886-8RFA 3V3	22480562 <sub>H</sub>	-	-
XC888-8RFA 3V3	22480563 <sub>H</sub>	-	-
XC886CM-6RFA 3V3	22491502 <sub>H</sub>	-	-
XC888CM-6RFA 3V3	22491503 <sub>H</sub>	-	-
XC886C-6RFA 3V3	22491542 <sub>H</sub>	-	-
XC888C-6RFA 3V3	22491543 <sub>H</sub>	-	-
XC886-6RFA 3V3	22491562 <sub>H</sub>	-	-
XC888-6RFA 3V3	22491563 <sub>H</sub>	-	-
XC886CLM-8RFA 5V	22800502 <sub>H</sub>	-	-
XC888CLM-8RFA 5V	22800503 <sub>H</sub>	-	-
XC886LM-8RFA 5V	22800522 <sub>H</sub>	-	-
XC888LM-8RFA 5V	22800523 <sub>H</sub>	-	-
XC886CLM-6RFA 5V	22811502 <sub>H</sub>	-	-
XC888CLM-6RFA 5V	22811503 <sub>H</sub>	-	-
XC886LM-6RFA 5V	22811522 <sub>H</sub>	-	-
XC888LM-6RFA 5V	22811523 <sub>H</sub>	-	-
XC886CM-8RFA 5V	22880502 <sub>H</sub>	-	-
XC888CM-8RFA 5V	22880503 <sub>H</sub>	-	-
XC886C-8RFA 5V	22880542 <sub>H</sub>	-	-
XC888C-8RFA 5V	22880543 <sub>H</sub>	-	-
XC886-8RFA 5V	22880562 <sub>H</sub>	-	-
XC888-8RFA 5V	22880563 <sub>H</sub>	-	-
XC886CM-6RFA 5V	22891502 <sub>H</sub>	-	-

## 4.2.2 Supply Threshold Characteristics

**Table 39** provides the characteristics of the supply threshold in the XC886/888.



**Figure 38** Supply Threshold Parameters

**Table 39** Supply Threshold Parameters (Operating Conditions apply)

Parameters	Symbol		Limit Values			Unit
			min.	typ.	max.	
$V_{DDC}$ prewarning voltage <sup>1)</sup>	$V_{DDCPW}$	CC	2.2	2.3	2.4	V
$V_{DDC}$ brownout voltage in active mode <sup>1)</sup>	$V_{DDCBO}$	CC	2.0	2.1	2.2	V
RAM data retention voltage	$V_{DDCRDR}$	CC	0.9	1.0	1.1	V
$V_{DDC}$ brownout voltage in power-down mode <sup>2)</sup>	$V_{DDCBOPD}$	CC	1.3	1.5	1.7	V
$V_{DDP}$ prewarning voltage <sup>3)</sup>	$V_{DDPPW}$	CC	3.4	4.0	4.6	V
Power-on reset voltage <sup>2)4)</sup>	$V_{DDCPOR}$	CC	1.3	1.5	1.7	V

1) Detection is disabled in power-down mode.

2) Detection is enabled in both active and power-down mode.

3) Detection is enabled for external power supply of 5.0V.  
Detection must be disabled for external power supply of 3.3V.

4) The reset of EVR is extended by 300  $\mu$ s typically after the VDDC reaches the power-on reset voltage.

**Electrical Parameters**
**4.3.2 Output Rise/Fall Times**

**Table 45** provides the characteristics of the output rise/fall times in the XC886/888.

**Table 45 Output Rise/Fall Times Parameters (Operating Conditions apply)**

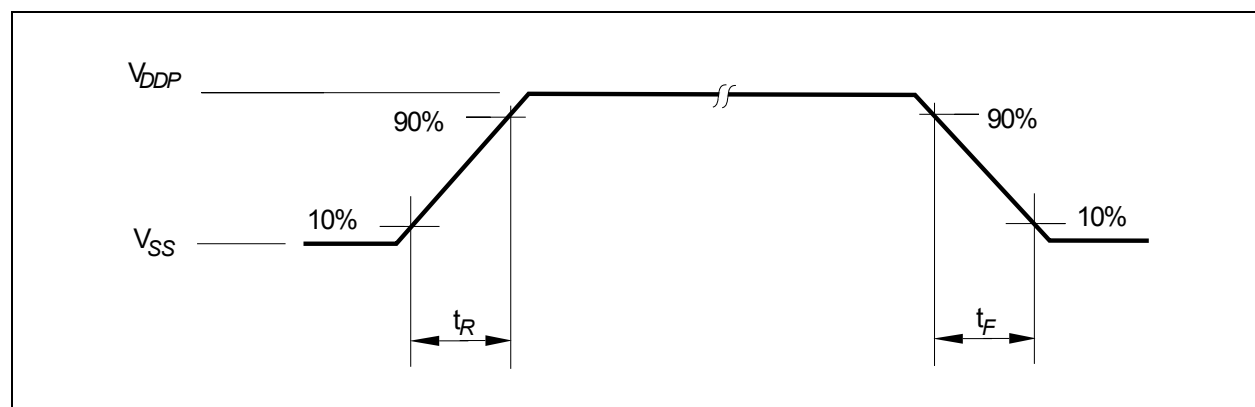
Parameter	Symbol	Limit Values		Unit	Test Conditions
		min.	max.		
<b><math>V_{DDP}</math> = 5V Range</b>					
Rise/fall times	$t_R, t_F$	–	10	ns	20 pF. <sup>1)2)3)</sup>
<b><math>V_{DDP}</math> = 3.3V Range</b>					
Rise/fall times	$t_R, t_F$	–	10	ns	20 pF. <sup>1)2)4)</sup>

1) Rise/Fall time measurements are taken with 10% - 90% of pad supply.

2) Not all parameters are 100% tested, but are verified by design/characterization and test correlation.

3) Additional rise/fall time valid for  $C_L = 20pF - 100pF @ 0.125 ns/pF$ .

4) Additional rise/fall time valid for  $C_L = 20pF - 100pF @ 0.225 ns/pF$ .



**Figure 43 Rise/Fall Times Parameters**